

Perfect Wireless Experience 完美无线体验

# L811-EA Series Module Hardware User Manual

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#### Versions

Version	Date	Remarks
V1.0.0	2014-10-17	Initial Version.
V1.0.1	2015-08-25	Update the logo.
V1.0.2	2015-09-08	Modify descriptions for power on and RTC timing.

## **Applicable Model List**

No.	Туре	Note
1	L811-EA	

The supported frequency bands of L811-EA wireless modules as shown in the following tables:

Model No.	LTE FDD	WCDMA	GSM/GPRS/EDGE
	Band		
L811-EA	1,2,3,4,5,7,8,13,17,	Band 1,2,4,5,8	850/900/1800/1900 MHz
	18,19,20		

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# **1** Foreword

# **1.1 Introduction**

The document describes the electrical characteristics, RF performance, dimensions and application environment, etc. of L811-EA wireless modules. With the assistance of the document and other instructions, developers can quickly understand the performance of L811-EA wireless modules and develop products.

## **1.2 Reference Standard**

The design of the product complies with the following standards :

- 3GPP TS 27.007 -v6.9.0: AT command set for User Equipment (UE)
- 3GPP TS 27.005 -v6.0.1: Use of Data Terminal Equipment -Data Circuit terminating Equipment (DTE-DCE) interface for Short Message Service (SMS) and Cell Broadcast Service (CBS)
- 3GPP TS 23.040 -v6.9.0: Technical realization of Short Message Service (SMS)
- 3GPP TS 24.011 -v6.1.0: Point- to Point (PP) Short Message Service (SMS) support on mobile radio interface
- 3GPP TS 27.010 -v6.0.0: Terminal Equipment to User Equipment (TE-UE) multiplexer protocol
- 3GPP TS 27.060 -v6.0.0: Packet domain; Mobile Station (MS) supporting Packet Switched services
- 3GPP TS 25.304-v6.10.0: User Equipment (UE) procedures in idle mode and procedures for cell reselection in connected mode
- 3GPP TS 25.308 -v6.4.0: High Speed Downlink Packet Access (HSDPA); Overall description; Stage 2
- 3GPP TS 25.309 -v6.6.0: FDD enhanced uplink; Overall description; Stage 2
- 3GPP TS 23.038 -v6.1.0: Alphabets and language specific information
- 3GPP TS 21.111 -v6.3.0: USIM and IC card requirements
- 3GPP TS 31.111 -v6.11.0 "USIM Application Toolkit (USAT)"
- 3GPP TS 45.002 -v6.12.0: Multiplexing and multiple access on the radio path
- 3GPP TS 51.014 -v4.5.0: Specification of the SIM Application Toolkit for the Subscriber Identity Module - Mobile Equipment (SIM-ME) interface
- 3GPP TS 51.010 -1 -v6.7.0: Mobile Station (MS) conformance specification; Part 1: Conformance specification
- 3GPP TS 22.004 -v6.0.0: General on supplementary services

- 3GPP TS 23.090 -v6.1.0: Unstructured Supplementary Service Data (USSD); Stage 2
- 3GPP TS 24.008 v6.19, Mobile radio interface Layer 3 specification;
- 3GPP TS 25.101 V7.18.0: User Equipment (UE) radio transmission and reception (FDD)
- 3GPP TS 36.101V9.18.0: User Equipment (UE) radio transmission and reception
- 3GPP TS 36.104V9.13.0: Base Station (BS) radio transmission and reception
- 3GPP TS 36.106V9.4.0: FDD Repeater radio transmission and reception
- 3GPP TS 36.113V9.5.0: Base Station (BS) and repeater ElectroMagnetic Compatibility (EMC)
- 3GPP TS 36.124V9.2.0: ElectroMagnetic Compatibility (EMC) requirements for mobile terminals and ancillary equipment
- 3GPP TS 36.133V9.18.0:Requirements for support of radio resource management
- 3GPP TS 34.121-1 version 7.2.0: The requirements and this test apply to all types of UTRA for the FDD UE
- 3GPP TS 36.521-1 User Equipment (UE) conformance specification; Radio transmission and reception; Part 1: Conformance testing
- 3GPP TS 34.122V5.7.0: Technical Specification Group Radio Access Network; Radio transmission and reception (TDD)
- 3GPP TS 45.005 9.4.0: Digital cellular telecommunications system (Phase 2+);Radio transmission and reception



# **2 Product Overview**

# 2.1 Description

The L811-EA modules are highly integrated wireless communication LTE modules, which support three modes and twelve bands, including the 4G/3G/2G mainstream modes (LTE FDD/WCDMA/GSM) for Europe and North America and cover a wide range of frequency bands. The modules support the cellular communication networks of Europe, North America as well as the mobile operators in some regions of Asia.

# 2.2 Specifications

Specifications							
	L811-EA						
Operating	LTE FDD: Band 1,2,3,4,5,7,8,13,17,18,19,20						
Frequency Range	WCDMA HSPA+: Band 1	,2,4,5,8					
	GSM/GPRS/EDGE: 850/	900/1800/1900MHz					
	LTE FDD	Category 4 (150Mbps DL,50Mbps UL)					
	UMTS/HSDPA/HSUPA	DC-HSDPA 42Mbps(Cat24)					
Data Data	3GPP Rel.8	HSUPA 11.5Mbps(Cat7)					
Data Rate		EDGE (E-GPRS) multi-slot class 33(296kbps DL,					
	GSM 3GPP release 7	236.8kbps UL)					
		GPRS multi-slot class 33 (107kbps DL, 85.6kbps UL)					
GPS	Not supported.						
	Dimension: 32 x 26 x 2.0mm						
Physical	Interface: LGA						
Characteristics	Weight: 4 grams						
	Operating Temperature:	-40°C ~ +85°C					
Environment	Storage Temperature: -4	<b>40</b> ℃ ~ +85℃					

Performance							
Operating Voltage	Voltage: 3.3V ~ 4.4V Normal: 3.8V						
	4mA (Sleep Mode)						
Current	LTE FDD DATA: 700mA						
Consumption	WCDMA Talk: 570mA						
	2G Talk: 250mA (GSM PCL5)						
Interfaces							
RF Interface	Antenna: Main x1, Diversity x1						
	USB 2.0 x1, Multiple Profiles over USB						
Function Interface	SIM Support, I2C Support, I2S/PCM Support						
	GPIO, Clock						
Data Features							
Protocol Stack Embedded TCP/IP and UDP/IP protocol stack							
	Multi-slot class 33 (5 Down; 4 Up; 6 Total)						
EDGE	Coding Scheme MCS1~9						
0000	Multi-slot class 33 (5 Down; 4 Up; 6 Total)						
GPRS	Coding Scheme MCS1~4						
CSD	UMTS(14.4kbps), GSM(9.6kbps)						
USSD	Supported						
SMS	MO / MT Text and PDU modes						
	Cell broadcast						
	Digital Audio						
Audio	Voice Coders: EFR/HR/FR/AMR						
	VoLTE (not supported yet)						
Audio Control	Gain Control						
Character Set	IRA, GSM, UCS2, HEX						

	FIBOCOM proprietary AT commands			
AT Commands	GSM 07.05			
	GSM 07.07			
	Firmware Loader Tool over USB/UART			
Accessories	User Manual			
	Developer Kit			

#### Note:

- 1. Please make sure the temperature for device will not be higher than 85°C.
- 2. The minimum distance between the user and/or any bystander and the radiating structure of the transmitter is 20cm.
- Assessment of compliance of the product with the requirements relating to the Radio and Telecommunication Terminal Equipment Directive (EC Directive 1999/5/EC) was performed by PHOENIX TESTLAB (Notified Body No.0700),

# <€ 0700



#### Note:

#### Federal Communications Commission (FCC) Declaration of Conformity

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

This device has been tested and found to comply with the limits for a Class B digital , pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiated radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

-Reorient or relocate the receiving antenna.

-Increase the separation between the equipment and receiver.

-Connect the equipment into an outlet on a circuit different from that to which the receiver is connected. -Consult the dealer or an experienced radio/TV technician for help.

#### **FCC Caution:**

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

#### **RF Exposure Information**

This device meets the government's requirements for exposure to radio waves. This device is designed and manufactured not to exceed the emission limits for exposure to radio frequency (RF) energy set by the Federal Communications Commission of the U.S. Government.

•This device complies with FCC radiation exposure limits set forth for an uncontrolled environment. In order to avoid the possibility of exceeding the FCC radio frequency exposure limits, human proximity to the antenna shall not be less than 20cm (8 inches) during normal operation.

#### **IMPORTANT NOTE:**

This module is intended for OEM integrator. The OEM integrator is still responsible for the FCC

compliance requirement of the end product, which integrates this module. 20cm minimum distance has to be able to be maintained between the antenna and the users for the host this module is integrated into. Under such configuration, the FCC radiation exposure limits set forth for an population/uncontrolled environment can be satisfied.

Any changes or modifications not expressly approved by the manufacturer could void the user's authority to operate this equipment.

#### USERS MANUAL OF THE END PRODUCT:

In the users manual of the end product, the end user has to be informed to keep at least 20cm separation with the antenna while this end product is installed and operated. The end user has to be informed that the FCC radio-frequency exposure guidelines for an uncontrolled environment can be satisfied. The end user has to also be informed that any changes or modifications not expressly approved by the manufacturer could void the user's authority to operate this equipment. If the size of the end product is smaller than 8x10cm, then additional FCC part 15.19 statement is required to be available in the users manual: This device complies with Part 15 of FCC rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference and (2) this device must accept any interference received, including interference that may cause undesired operation.

#### LABEL OF THE END PRODUCT:

The final end product must be labeled in a visible area with the following " Contains TX FCC ID: ZMOL811". If the size of the end product is larger than 8x10cm, then the following FCC part 15.19 statement has to also be available on the label: This device complies with Part 15 of FCC rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference and (2) this device must accept any interference received, including interference that may cause undesired operation.



## 2.3 Appearance

Top View:



Figure 2-1 Top View

Bottom view:



Figure 2-2 Bottom View



# **3 Structure**

# **3.1 Dimension Diagram of Structure**



Figure 3-1 Dimension Diagram of Structure

# 3.2 Recommended PCB Layout Design



Figure 3-2 Perspective drawing of top view



Figure 3-3 Structure Diagram of PCB Layout

# **4 Hardware Introduction**

# 4.1 Pin Definition

## 4.1.1 Pin Map



Figure 4-2 Pins Definition

## 4.1.2 Description of Pins

The logic signal level of L811-EA module is 1.8V.

Pin#	Pin Name	I/O	Reset Value	ldle Value	Description		
Power	Power						
N3	VBAT	PI			Power input		
N4	VBAT	PI			Power input		
M3	VBAT	PI			Power input		
M4	VBAT	PI			Power input		
N5	VRTC	PO			VRTC output		
N6	VSD2_1V8	PO			VSD2_1V8 output		
POWE	R_ON/OFF#,RESET	1					
N7	RESET_N	I			Module reset input, pull up(100K ohms),1.8V		
N8					Module power on/off signal, pull down (200K		
					ohms),1.8V		
I2S	1	1			F		
N9	I2S2_WA	0	PD	Т	I2S LRCK,CMOS 1.8V		
N10	I2S2_TX	0	PD	Т	I2S data transmit, CMOS 1.8V		
N11	I2S2_RX	I	PD	Т	I2S data receive, CMOS 1.8V		
N12	I2S2_CLK	0	PD	Т	I2S serial clock, CMOS 1.8V		
I2C			-				
M11	I2C_SDA	ю	PU	PU	I2C serial data, pull up(4.7K ohms)CMOS 1.8V		
M12	I2C_SCL	ο	PU	PU	I2C serial clock, pull up(4.7K ohms)CMOS 1.8V		
Clock	1	<u> </u>	<u> </u>				
A3	FSYS2_26M	0			26MHz clock output,1.8V		
A8	CLK32K	0	PD	PD	32kHz clock output,1.8V		
SIM1	·				·		
D15	VSIM1	PO			SIM1 power supply,1.8V/2.8V		
E15	SIM1_RST	0	L		SIM1 reset		
F15	SIM1_CLK	0	L		SIM1 clock		



G15	SIM1_DATA	Ю	L		SIM1 data, internal 4.7K resistor pull up
H15	SIM1_CD		Т		SIM1 detect, pull up(390K ohms)CMOS 1.8V
F14	SIM1_DP	Ю	PD		USB data plus for SIM1 card
G14	SIM1_DN	Ю	PD		USB data minus for SIM1 card
USB2.	D				
A11	VBUS	ΡI			USB VBUS Supply
A12	USB_DN	Ю	Т		USB Data Minus
A13	USB_DP	Ю	Т		USB Data Plus
USB3.	D				
C13	NC				
B13	NC				
C14	NC				
B14	NC				
HSIC					_
B12	USB_HSIC_STRB	Ю			High speed Inter IC clock (not supported now)
C12	USB_HSIC_DATA	Ю			High speed Inter IC data (not supported now)
C4	IPC_HOST_WAKEU P	0	PU	н	IPC host wakeup (not supported now)
C5	IPC_TRIG_OUT	0	PD	L	IPC trig out (not supported now)
C7	IPC_TRIG_IN	I	PU	PU	IPC trig in (not supported now)
C8	IPC_SLAVE_WAKEU P	Ι	PD		IPC slave wake up (not supported now)
SSIC					
D14	NC				
E14	NC				
D13	NC				
E13	NC				
UART1					
A9	UART1_TXD	0	PU	PP	UART1 transmit Data, CMOS 1.8V
A10	UART1_RXD	I	PD	PU	UART1 receive Data, CMOS 1.8V
K14	UART1_RTS	0	PU	PP	UART1 Request To Send, CMOS 1.8V

L14	UART1_CTS	I	PU	PU	UART1 Clear To Send, CMOS 1.8V		
EINT	_			_			
J15	WAKEUP	Ι	PD	PU	WAKEUP,CMOS 1.8V		
K15	W_DISABLE#	Ι	PD	PU	W_DISABLE#,CMOS 1.8V		
H14	EINT3	Ι	PD	PU	EINT3,CMOS 1.8V		
J14	BODY_SAR	Ι	PU	PU	BODY_SAR,CMOS 1.8V		
Syster	System status indicator						
A4	CORE_DUMP	0	PD	L	Core dump indicator, CMOS 1.8V		
A5	LPG	0	PD		LPG,CMOS 1.8V		
A7	WAKEUP_HOST	0	PD	L	WAKEUP_HOST,CMOS 1.8V		
L15	PA_BLANKING/ TRIG_OUT(T_OUT1)	0	PD	L	PA blanking output/Monitoring Signal Output, CMOS 1.8V		
ADC							
C10	NC						
JTAG							
L5	TDO	0	Т		Serial Data Out		
M10	TDI	I	PU		Serial Data Input		
M7	TMS	I	PU		State machine control signal		
M9	ТСК	I	PD		JTAG clock input		
M5	TRST_N	Ι	PD		Reset/Module enable		
M6	TRIG_IN	Ι	PD		Monitoring Signal Input, CMOS 1.8V		
MIPI2	Ггасе						
L7	MIPI2_TRC_CLK	0	PD	PP	MIPI2 trace clock, CMOS 1.8V		
L6	MIPI2_TRC_DATA0	Ю	PD	PP	MIPI2 trace data0,CMOS 1.8V		
L9	MIPI2_TRC_DATA1	Ю	PD	PP	MIPI2 trace data1,CMOS 1.8V		
L10	MIPI2_TRC_DATA2	Ю	PD	PP	MIPI2 trace data2,CMOS 1.8V		
L11	MIPI2_TRC_DATA3	10	PD	PP	MIPI2 trace data3,CMOS 1.8V		
ANT T	unable						
В5	RFE_RFFE1_SDATA	Ю		PP	RFFE1 serial data for tunable ANT,CMOS 1.8V		
B4	RFE_RFFE1_SCLK	0		PP	RFFE1 serial clock for tunable ANT,CMOS 1.8V		



В3	RFE_RFFE1_VIO	PO	RFFE1 VIO for tunable ANT,1.8V
ANT			
J1	ANT_MAIN	ю	Main antenna
E1	ANT_DIV	I	Diversity antenna
B8	GND		GND
B9	GND		GND
B10	GND		GND
B11	GND		GND
C11	GND		GND
F13	GND		GND
L12	GND		GND
M13	GND		GND
L13	GND		GND
G13	GND		GND
H13	GND		GND
J13	GND		GND
K13	GND		GND
A6	GND		GND
B2	GND		GND
B6	GND		GND
B7	GND		GND
C1	GND		GND
C2	GND		GND
C3	GND		GND
C6	GND		GND
C9	GND		GND
C15	GND		GND
D1	GND		GND
D2	GND		GND
D3	GND		GND
D4	GND		GND

D12	GND	GND
E2	GND	GND
E3	GND	GND
F1	GND	GND
F2	GND	GND
F3	GND	GND
G1	GND	GND
G2	GND	GND
G3	GND	GND
H1	GND	GND
H2	GND	GND
Н3	GND	GND
J2	GND	GND
J3	GND	GND
K1	GND	GND
K2	GND	GND
К3	GND	GND
K4	GND	GND
K12	GND	GND
L1	GND	GND
L2	GND	GND
L3	GND	GND
L4	GND	GND
L8	GND	GND
M2	GND	GND
M8	GND	GND
M14	GND	GND
N13	GND	GND
A1	GND	GND
A15	GND	GND
N1	GND	GND

N15	GND	G	GND
TG1	GND	G	GND
TG2	GND	G	GND
TG3	GND	G	GND
TG4	GND	G	GND
TG5	GND	G	GND
TG6	GND	G	GND
TG7	GND	G	GND
TG8	GND	G	GND
TG9	GND	G	GND
TG10	GND	G	GND
TG11	GND	G	GND
TG12	GND	G	GND
TG13	GND	G	GND
TG14	GND	G	GND
TG15	GND	G	GND
TG16	GND	G	GND

H: High Voltage Level

L: Low Voltage Level

PD: Pull-Down

PU: Pull-Up

T: Tristate

OD: Open Drain

PP: Push-Pull

Note : The unused pins can be left floating in case of circuit design.

# **5 Hardware Interface**

# 5.1 Power Interface

## 5.1.1 Power Supply

The L811-EA module requires a 3.3V - 4.5V DC power supply that capable of supplying maximum GSM emission current which may up to 2A.

Input power supply requirements:

Parameter	Minimum Value	Recommended Value	Maximum Value	Unit
VBAT	3.3	3.8	4.4	V

#### Important notes for the power supply:

1. Voltage fluctuation of the power supply should be lower than 200mV.

2. VBAT should not lower than 3.3V when the voltage dropping occurs.

The filtering capacitors for designing the power supply as shown in the following tables:

Recommended capacitance	Application	Description	
330uE	Power supply	Reduce voltage fluctuation during the phone call.	
		For capacitance value, the bigger the better.	
1uE 100nE	Digital signal noise	Filter for the interference caused by clock and	
	Bigital bigital holde	digital signals.	
39pF,33pF	700 /850 /900 MHz	Filter for RF interference.	
	1700/1800/1900,	Filter for DE interference	
iopr,o.∠pr,o.opr	2100/2600MHz		

## 5.1.2 VSD2\_1V8

VSD2\_1V8 is the power source of the internal digital circuits, it can be also used as the power indicator and the reference voltage. For circuit design, it can be only used for low current application (<50mA), floating if not used.



Parameters	Minimum Value	Typical Value	Maximum Value	Unit
VSD2_1V8	1.7135	1.8	1.8865	V
VIH	0.7* VSD2_1V8	1.8	1.8865	V
VIL	-0.3	0	0.3* VSD2_1V8	V

## 5.1.3 VRTC

VRTC is the power supply for the internal RTC of the module. In order to let RTC work for a certain time when lost the VBAT power, as the backup power, it is recommended to add a big capacitor at the VRTC pin.

The voltage range of the VRTC as shown in the following tables:

Parameters	Minimum Value	Recommended Value	Maximum Value	Unit
RTC working voltage	0.4	1.8	1.89	V
Voltage of VRTC	RTC Current Consu	umption		
0.4V ~ 1V	1 uA			
1V ~ 1.89V	2 uA			

The reference design of VRTC circuit shown as follows:



Figure 5-1 VRTC Reference Design

#### Note:

- R8 is a current-limiting resistor, used to ensure the VRTC works properly and free from being affected by peripheral circuits. R8 ≥ 1k Ohm.
- The current consumption is about 2A when 1.8V VRTC is supplied from the external capacitor.
- The value of C9 will affect the retaining time of RTC after VBAT is lost. The remaining time of RTC can be roughly calculated by the following formula:

(1.8-1)\*C/2 + (1-0.4)\*C/1 = 0.4C + 0.6C = 1C

Ex.

When using a 100 $\mu$ F capacitor, the remaining time is 1\*100 = 100 Sec.

When using a 330uF capacitor, the remaining time is 1\*330 = 330 Sec.

• If the RTC backup power function is not required, the VRTC pin can be left floating.

# 5.2 Power on/off and Reset Signal

The L811-EA module provides two control signals for power on/off and reset functions.

Pin definition as shown in the following tables:

Pin#	Pin Name	Electrical Level	Description
N8	POWER_ON/OFF#	CMOS 1.8V	Power on/off signal
N7	RESET_N	CMOS 1.8V	External reset signal input, active low.

## 5.2.1 Power on /off Signal

#### 5.2.1.1 Power on

After the power is applied to the module, pull up the POWER\_ON/OFF# signal for at least 20ms then the module will boot up.

The timing sequence diagram as follows:



#### Figure 5-2 Power on Timing Control Diagram

#### Note :

The ">1s" time starts from the external capacitor being charged when the power is applied to the module. If VBAT is already applied to the module then the time can be ignored, and AP(Application Processor)

only needs to control the timing of RESET\_N and POWER\_ON/OFF# signals.

#### 5.2.1.2 Power off

The L811-EA module can be turned off by software or hardware control. Software control is preferred for normal cases, only when software control is not usable, then use the hardware control. By pulling down or float the POWER\_ON/OFF# signal, the module will be shut down.<sup>(1)</sup>

For details as shown in the following tables:

Control Method	Action	Condition
Software	AT+CPWROFF	Normal control for power off.
Hardware	Pull down or floating the POWER_ON/OFF# signal.	Only used when a hardware exception occurs and the software control cannot be used.

The hardware control description:

By pulling down or float the POWER\_ON/OFF# signal, the PMU (Power Management Unit) of the module will be reset, which results in the state changes from the working state to the shutdown state.

The timing sequence diagram as follows:



Figure 5-3 Power off Timing Sequence Diagram

**Note** <sup>0</sup>: To safely shut down the module, the RESET\_N signal must be pulled down (for at least 100ms) before pulling down the POWER\_ON/OFF# signal.

## 5.2.1.3 The Recommended Design of Power on/off

The recommended design of POWER\_ON/ OFF# signal is as follows:



Figure 5-4 Recommended Design of POWER\_ON/OFF# Signal

## 5.2.2 RESET Signal

The L811-EA module supports the external reset function. By controlling the RESET\_N signal, the module will reset to its initial state. When pulling down the RESET\_N signal for 100ms, the module will be reset and restarted. If the module is already turned on and working before the reset, there is no need to control POWER\_ON/OFF# signal to turn it on. PMU inside the module remains its power during the reset procedure.

#### Note:

The reset signal is very sensitive. It should be kept away from RF interference and well wrapped with ground planes in case of PCB layout. It is recommended to add a filter capacitor close to the module. Also, RESET\_N signal trace shall neither near the PCB edge nor route on the surface planes to avoid module from reset caused by ESD.

The	timina	sequence	requirement	as	follows:
THE	unnig	Sequence	requirement	as	10110110

Parameter	Condition	Minimum Value	Typical Value	Maximum Value	Unit
Pulse Width	Reset	7	100	1000	ms



#### Recommended design:



Figure 5-5 Recommended Design of Reset Circuit

## 5.3 Status Indicating Signals

Pin#	Pin Name	I/O	Description
A4	CORE_DUMP	0	Core Dump Indicator
A5	LPG	0	LPG status Indicating
A7	WAKEUP_HOST	0	The module wakes up the host (Application processor).
L15	PA_BLANKING	0	PA Blanking output, external GPS control signal.

## 5.3.1 CORE DUMP Indicating

The CORE\_DUMP signal is used to indicate the mode of the module.

Status	Mode
Normal mode	Low level
Core Dump	High level

## 5.3.2 LPG Signal

The LPG signal timing description as shown in the following tables:

Operating Modes

LPG signal



Idle (unregistered)	600ms high level and 600ms low level		
Idle (registered)	75ms high level and 3s low level		
Voice communication (Call)	Always low level		
Data communication	75ms high level and 75ms low level		
Sleep (sleep mode)	Always high level		
0.0 ms 500.0 ms	1.0 s 1.5 s 2.0 s 2.5 s 3.0 s 3.4		
Idle(unregistered)			
Idle(registered) 75	3000		
DATA TX/RX 75-75-75-			
SLEEP			

## 5.3.3 WAKEUP\_HOST Signal

The WAKEUP\_HOST signal is used to wake up the host when there are incoming calls, SMS or other data requests.

Status	WAKEUP_HOST Signal
Default	High level
Waking HOST(telephone ringing/SMS/other data request)	Low level

## 5.3.4 PA\_BLANKING Signal

The default is low for the signal. While the module works in GSM frequency band, PA\_BLANKING will output the pulses that synchronized with the GSM burst timing sequence.

Due to the GSM TX may interfere the receiving of the GPS signal, AP can turn off GPS or stop receiving data from the GPS when it detecting the PA\_BLANKING pulses.

Operating modes	PA_BLANKING Signal		
Default modes	Low level		
GSM TX	Output the pulse signal that synchronize with the GSM burst		

# 5.4 Interrupt Control Signal

The interrupt control signals as shown in the following tables:

Pin#	Name	I/O	Description
J15	WAKEUP	I	Wake up the module.
K15	W_DISABLE#	I	Enable/Disable RF network.
H14	EINT3	I	Android & Linux/Win8 & Win10 dual systems switch.
J14	BODY_SAR	I	Body SAR detection.

## 5.4.1 WAKE\_UP Signal

WAKE\_UP signal description as shown in the following tables:

Module Mode	WAKE_UP Signal	Description
Sleep	Low level	Wake up the module from Sleep to Idle mode
	High level	Keep the module in Sleep mode
Idle/Call	Low level	Keep the current mode
	High level	The module will not enter Sleep mode

## 5.4.2 W\_DISABLE# Signal

The module provides a hardware signal to enable/disable WWAN RF function, it can be controlled by an

AT command also. The module will enter the Airplane mode by disabling RF function.

No.	W_DISABLE#	Function
1	Low	WWAN disabled, module enters Airplane mode.
2	High	WWAN enabled, module exits Airplane mode.
3	Floating	The WWAN function is defined by the AT command, enabled by default.

The definition of W\_DISABLE# signal as shown in the following tables:

# 5.4.3 Android & Linux / Win8 & Win10 Dual Systems Switch Control Signal

The L811-EA module supports Android & Linux / Win8 & Win10 dual systems switch by detecting the

voltage level of the interrupt signal EINT3.

The function of EINT3 signal as shown in the following tables:

No.	EINT3	Function



1	High/Floating	For Android or Linux system, the module`s USB ports mapped as 3*ACM	
			ports.
	2	Low	For Win8 or Win10 system, the module's USB port is mapped as a MBIM
-	2011	mode.	

Description:

- 1. During booting, the implementation of Android & Linux / Win8 & Win10 system change is done by detecting the level of EINT3 signal. The voltage level of EINT3 should be kept stable during booting.
- After boot up, the implementation of Android & Linux / Win8 & Win10 system change is done by detecting the rising or falling edge of the EINT3 interrupt with the debounce time of 100ms. If the interrupt event meets the condition, the module will restart and change over its USB mode for the desired system.

# 5.5 USB Interface

## 5.5.1 USB Interface Definition

Pin#	Pin Name	I/O	Description
A13	USB_DP	I/O	USB D+ signal
A12	USB_DN	I/O	USB D- signal
A11	VBUS	I	USB power input

The L811-EA wireless communication module supports USB 2.0 interface. Before connecting it to the Win7 system, it is necessary to install the USB driver (For Android & Linux system, no USB driver needed but configuring the related kernel settings). After connecting the USB port to a PC, the USB driver resides in the Windows system will map three ACM ports and four NCM ports, as listed below:

- 2 ACM ports used for AT Commands.
- 1 ACM ports used for LOG information captured by the debug software.
- 4 NCM ports are virtual network ports, mainly used for initiating data transmission serves.

#### Note:

One of the ACM ports can be used as a Modem COM port to initiate the data services. It is not recommended to use due to the speed of Modem COM port is insufficient for the 100Mbps download speed of the LTE standard. Only when the NCM ports are not available, the Modem COM port could initiate the data service as the temporary solution.

## 5.5.2 USB Interface Application

#### Reference Circuit Design:



Figure 5-6 USB Interface Reference Circuit Design

The choice of capacitance for RV101 and RV102 TVS diodes should not greater than 1pF, it is recommended to use 0.5pF TVS diodes. There is no recommended capacitance value for RV100.

VUSB pin supplies the power for USB, the recommended power range is  $3.3V \sim 4.5V$ . VBUS pin should not floated or it will become the unknown device.

USB\_DP and USB\_DM are the high-speed differential signals, and the maximum data rate is 480Mbps. The following requirements should be followed in case of PCB layout.

- USB\_DP and USB\_DN signal traces should be parallel and have the equal length, avoid right angle layout.
- USB\_DP and USB\_DN signal traces should be wrapped with GND on both sides.
- USB2.0 differential signal traces should be routed on the layer nearest to the ground plane.
- Ensure the match of impedance, which is required to be 90 Ohm.

#### Note:

VBUS is the power for USB detection (it's the low current signal, current value < 100uA). In circuit design, it's not permitted to apply VBUS power individually when the USB\_DN and USB\_DP are disconnected, or the module will not go into the sleep mode.

# 5.6 UART Interface

## 5.6.1 UART Interface Description

The L811-EA module provides one 4-wire UART port. The UART1 port supports AT commands, the users can receive and transmit AT commands through UART1.

Pin#	Pin Name	I/O	Description
L14	UART1_CTS	I	Clear to send
K14	UART1_RTS	0	Request to send
A9	UART1_TXD	0	Data Transmit
A10	UART1_RXD	I	Date Receive

The definition of UART1 signals as shown in the following tables:

## 5.6.2 UART Interface Application

The signal direction when connecting the UART1 of L811-EA module (DCE) and MCU (DTE) as shown in the following tables:

MCU (DTE) application	Signal direction	L811-EA module (DCE)
RXD	•	UART1_TXD
TXD		UART1_RXD

#### Note:

The voltage level of UART interface is 1.8V. When connecting to 2.8V or 3.3V I/O, it is necessary to convert the voltage level. In circuit design, it is recommended to use a SN74LVC2G07 to convert the voltage level from 1.8V to 3.3V. For connecting to a PC, first convert 1.8V to 3.3V, then use a SPIEX3232EEA to convert it to RS-232 level. The direction of the signals should be properly handled.

# 5.7 USIM Interface

The L811-EA module supports USIM and high speed SIM cards (The 8-wire USIM is not supported yet).

## 5.7.1 USIM Pins

Pin#	Pin Name	I/O	Function Description
D15	VSIM1	0	USIM power, 1.8V/2.8V
E15	SIM1_RST	0	USIM reset
F15	SIM1_CLK	0	USIM clock
G15	SIM1_DATA	I/O	USIM data
H15	SIM1_CD	1	USIM card detection signal, pulled up with a 390k resistor by default.
			High when SIM card is inserted.
			Low when SIM card is not inserted.

## 5.7.2 USIM Interface Design

## 5.7.2.1 "Normally Closed" SIM Card Circuit Design

Reference Circuit Design::



Figure 5-7 Reference Design of "Normally Closed" SIM Card Interface

Normally closed SIM Connector:

- 1) When detaching the SIM card, pin 7 and pin 8 shorted together.
- 2) When inserting the SIM card, pin 7 and pin 8 opened.

#### 5.7.2.2 "Normally Open" SIM Circuit Design

Referenced Circuit Design:



Figure 5-8 Reference Design of "Normally Open" SIM Card Interface

Normally open SIM Connector:

- 1) When detaching the SIM card, pin 7 and pin 8 opened .
- 2) When inserting the SIM card, pin 7 and pin 8 shorted.

Note:

- In order to improve the EMC performance, the SIM card slot should be close to the module as much as possible.
- The filter capacitors for the SIM card signals should be placed close to the SIM card slot as much as possible.
- The ESD devices (e.g. TVS) shall be added to the SIM card signals for ESD protection. They should be placed close to the SIM card slot as much as possible.
- SIM1\_CD signal supports hot-plugging. Active high by default (It can be changed to active low by an AT command). If the module detects the signal with high level, it means a card insertion has detected.

## 5.7.3 Highlights for USIM Design

The SIM card interface design is very important to have the module and SIM card work normally.

The rules should be followed carefully as below:

- SIM card slot and signal routing must keep away from the EMI interference sources, e.g. RF antenna and digital signals.
- The trace length between the module and SIM card should not exceed 100mm.
- To avoid crosstalk, USIM\_CLK and USIM\_IO signals should keep away in case of layout. It's recommended to wrap them with ground planes.
- SIM card signals should be ESD protected. The ESD devices should have low capacitance (e.g. Zener diode). It's recommended to choose ESD devices with capacitance equal or less than 33pF. In case of layout, ESD devices should be close to the SIM card interface.

## 5.7.4 USIM Hot-Plugging

The L811-EA module supports the insert detection of the SIM card. With this function, the hot-plugging of SIM card can be designed.

### 5.7.4.1 Hardware Connection

The function of SIM card hot-plugging is done by the SIM\_CD signal. The SIM1\_CD signal is low when the SIM card is detached, high when the SIM card is inserted.

Note:

- For "Normally closed" design, as shown in the figure5-7, the SIM1\_CD signal is connected to U2's Pin8 (SW2), and Pin7 (SW1) is connected to the ground. When the SIM card is not inserted, SW2 and SW1 are shorted, and SW2 is low. When the SIM card is inserted, SW2 and SW1 are opened, and the SIM1\_CD signal will be pulled high.
- For "Normally open" design, as shown in the figure 5-8, the SIM1\_CD signal is connected to U2's Pin8

(SW2), and Pin7 (SW1) is pulled up with a 4.7K resistor. When the SIM card is not inserted, SW2 and SW1 are opened, and SW2 is low. When the SIM card is inserted, SW2 and SW1 are shorted, and SIM1\_CD signal will be pulled high.

#### 5.7.4.2 Software Setup

"+MSMPD" command is used for the SIM card detection function:

- If set AT+MSMPD=0, the SIM card detection function is disabled, and the module will not detect the SIM1\_CD signal.
- If set AT+MSMPD=1, the SIM card detection function is enabled, and the module will detect the insertion of the SIM card via SIM1\_CD Pin.
- If SIM1\_CD is high, which indicates the insertion of a SIM card, and the module will automatically register to the network.
- If SIM1\_CD is low or disconnected, which indicates the SIM card is not inserted, and the module will
  not register to the network.

#### Note:

The default value of +MSMPD is "1". The SIM\_CD signal is used for SIM card detection. The module detects the presence of the SIM card via the SIM1\_CD signal during the first booting. After the module boots up, it detects the SIM card by the level change of the SIM1\_CD signal. In other words, if SIM1\_CD is at low level, the module cannot access the SIM card.

# 5.8 Digital Audio

The L811-EA module supports I2S interface for digital audio. The I2S port supports normal I2S mode and PCM mode for data transfer. I2S interface is at 1.8V voltage level.

Pin#	Pin Name	I/O	Description
N12	I2S2_CLK	0	Bit clock, 1.8V signal
N9	12S2_WA0	0	Left and right channel clock (LRCK), 1.8V signal
N10	12S2_TX	0	Serial data output, 1.8V signal
N11	12S2_RX	I	Serial data input, 1.8V signal

I2S signal description as shown in the following tables:

## 5.8.1 I2S Interface

L811-EA Signal Directi	n Audio CODEC I2S Port
------------------------	------------------------



I2S2_CLK0		I2S_CLK
I2S2_WA0		I2S_LRCK
12S2_RX	•	I2S_SDOUT
12S2_TX		I2S_SDIN

Description:

- I2S interface can be configured as master or slave mode.
- It supports various audio sampling rates (48KHz, 44.1KHz, 32KHz, 24KHz, 22.5KHz, 16KHz, 12KHz, 11.025KHz and 8KHz).

## 5.8.2 PCM Mode Description

L811-EA	Signal Direction	Audio CODEC PCM Port
I2S2_CLK(PCM_CLK ,PCM clock signal)		PCM_CLK (PCM clock signal)
I2S2_WA(PCM_SYNC , PCM frame	PCM_SYNC (PCM frame	
synchronization signal)		synchronization signal)
I2S2_RX(PCM_DIN , PCM data input)	•	PCM_DOUT (PCM data output)
I2S2_TX(PCM_DOUT , PCM data output)		PCM_DIN (PCM data input)

#### Note:

- PCM port can be configured as master or slave mode.
- It supports short frame sync for 16, 32, 48, and 64 bit mode.
- It supports burst and continuous transmission modes.
- It supports clock length trigger for frame sync signal and rising/falling edge trigger for data transmission.
- It supports various audio sampling rates (48KHz, 44.1KHz, 32KHz, 24KHz, 22.5KHz, 16KHz, 12KHz, 11.025KHz and 8KHz).

#### Note:

Because of the timing of I2S mode is simpler than PCM mode, it is recommended to use I2S mode for audio transmission. For PCM mode, the audio quality issues caused by the PCM timing adjusting must be avoided.

# 5.9 I2C Interface

L811-EA module supports one I2C interface, default configured as I2C master. The I2C master is used for driving external I2C slave devices, such as audio codecs and so on.



Pin#	Name	I/O	Description
M11	I2C_DATA	I/O	I2C data signal,1.8V signal level
M12	I2C_SCL	0	I2C clock signal, 1.8V signal level

The signal connection of L811-EA I2C master and external I2C slave (such as an audio codec) as shown in the following tables:

L811-EA	Signal Direction	Audio Codec I2C Port
I2C_SDA	<b>←</b> →	I2C_SDA
I2C_SCL		I2C_SCL

# 5.10 Clock Interface

L811-EA module supports one 26MHz clock output and one 32KHz clock output.

Pin#	Pin Name	I/O	Description
42	ESVS2 26M		26MHz clock output, 1.8V level. (It is recommended to be
AS	F5152_20M	0	clock of the audio codec)
A8	CLK32K	0	32K clock output, 1.8V level.

# **5.11 Other Interfaces**

The module does not support the following ports yet: HSIC、ANT Tunable、GPIO.

# 6 Electrical and Environmental Characteristic

# 6.1 Electrical Characteristic

The table below lists the range of L811-EA's electrical characteristics:

Parameters	Minimum Value	Maximum Value	Unit
Power supply signal	0	4.4	V
Digital signal	0	1.9	V

# **6.2 Environmental Characteristic**

This table below shows the environmental features of L811-EA.

Parameters	Minimum Value	Maximum Value	Unit
Operating Temperature	-40	+85	°C
Storage Temperature	-40	+85	°C

# 7 RF Interface 7.1 RF PCB Design

## 7.1.1 Wire Routing Principle

The L811-EA module supports double RF antennas, the MAIN\_ANT is for transmitting and receiving, and the DIV\_ANT is for receiving. Diversity antenna can improve the receiver sensitivity as well as the downlink speed.

The RF connectors or solder joints must be connected to the L811-EA module by the trace lines. It is recommended to use the microstrip line for RF line. It should be as short as possible with the insertion loss controlled below 0.2dB, and has the impedance of 50 Ohm.

For antenna fine tuning, it is recommended to reserve a  $\pi$  circuit (the parallel inductors should connect to the main ground) between L811-EA module and the antenna connector (or the solder joint).



Figure 7-1 L811-EA π-type Circuit

## 7.1.2 Impedance

The impedance of the RF signal line needs to be controlled at 50 Ohm.

# 7.2 Antenna Design

## 7.2.1 Main Antenna Design Requirements

#### (1) Antenna efficiency

Antenna efficiency is the ratio of the input power and radiant power. Because of the return loss, material loss and coupling loss of the antenna, the radiant power is always lower than the input power. The ratio is recommended to be controlled over 40% (–4dB).

#### (2) S11 or VSWR

S11 indicates the matching level of the 50 Ohm impedance for the antenna. It affects the antenna efficiency in a certain extent. The VSWR testing method could be used for measuring purposes. The recommended value for S11 is less than –10dB.

#### (3) Polarization

Polarization refers to the rotation direction of electric field while the antenna is in the direction of maximum radiation. Linear polarization is recommended. It is recommended to use the diversity antenna which has the different polarization direction from the main antenna.

#### (4) Radiation pattern

The radiation pattern refers to the intensity of the electromagnetic field while the antenna is in every direction of the far field. Dipole antenna is perfect as the terminal antenna. For built-in antenna, it is recommended to use PIFA or IFA antennas.

- Antenna dimension: 6mm \* 10mm \* 100mm (H\*W\*L).
- Antenna radiation direction: Omnidirectional.

#### (5) Gain and directivity

Antenna directivity refers to the intensity of the electromagnetic field while the electromagnetic wave is in all directions. Gain is the collection of of the efficiency and directivity of the antenna. It is recommended that antenna gain is less than or equal to 3dBi.

#### (6) Interference

In addition to antenna performance, some other interference from the PCB will also affect the module performance. To ensure the high performance of the module, the interference must be under control. Suggestions: Keep speaker, LCD, CPU, FPC wire routing, audio circuits, and power supply away from the

antenna, and add appropriate filtering and shielding protection, or adding filtering devices on the traces.

#### (7) TRP/TIS

TRP (Total Radiated Power):

- GSM850/900>28dBm
- GSM DCS1800/PCS1900 >25dBm
- WCDMA Band 1,2,4,5,8>19dBm
- LTE FDD Band 1,2,3,4,5,7,8,13,17,18,19,20>19dBm

TIS (Total Isotropic Sensitivity):

- GSM850/900/DCS1800/PCS1900<-102dBm
- WCDMA Band 1,2,4,5,8<-102dBm
- LTE FDD Band 1,2,3,4,5,7,8,13,17,18,19,20<-95dBm (10MHz Bandwidth)